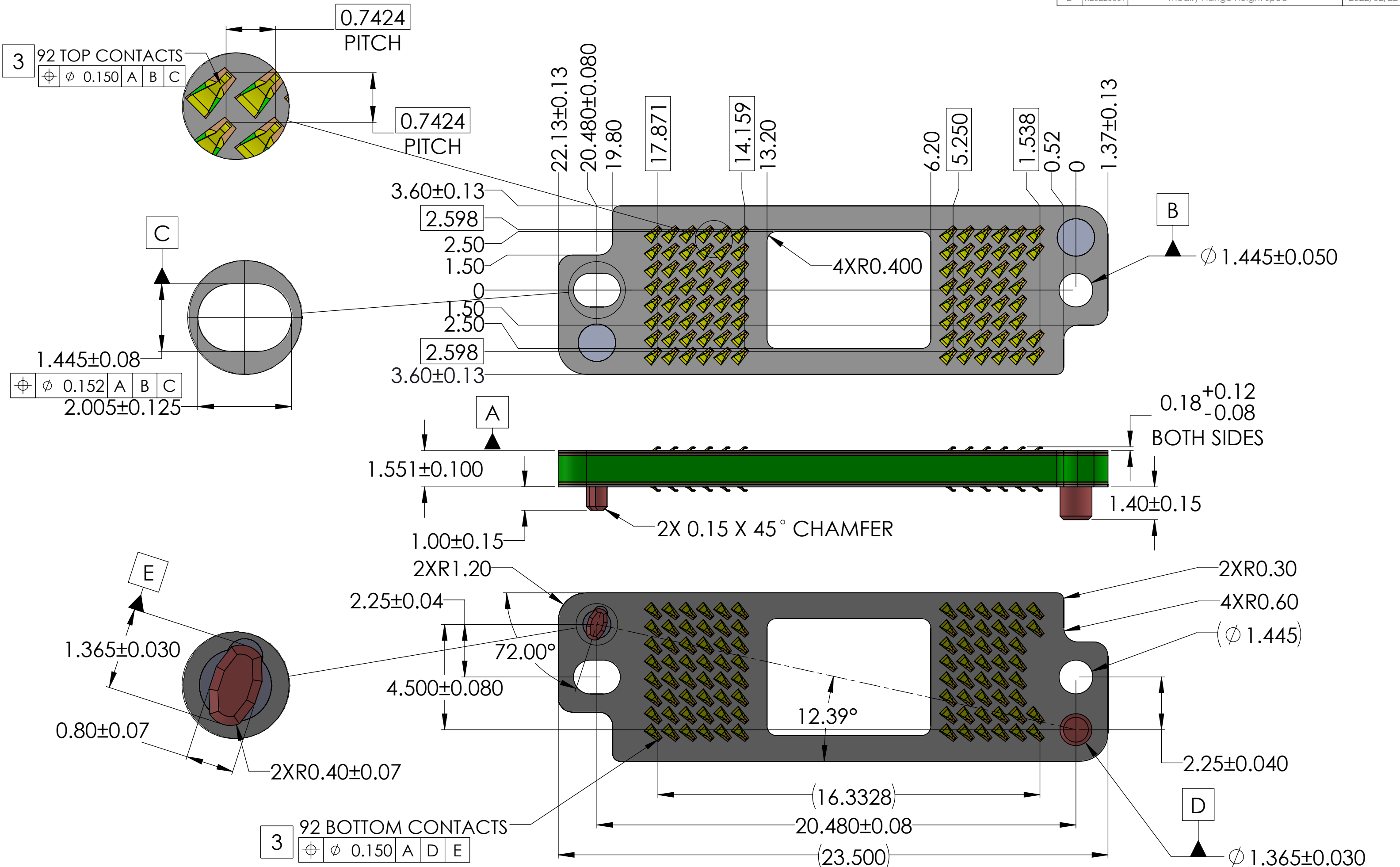


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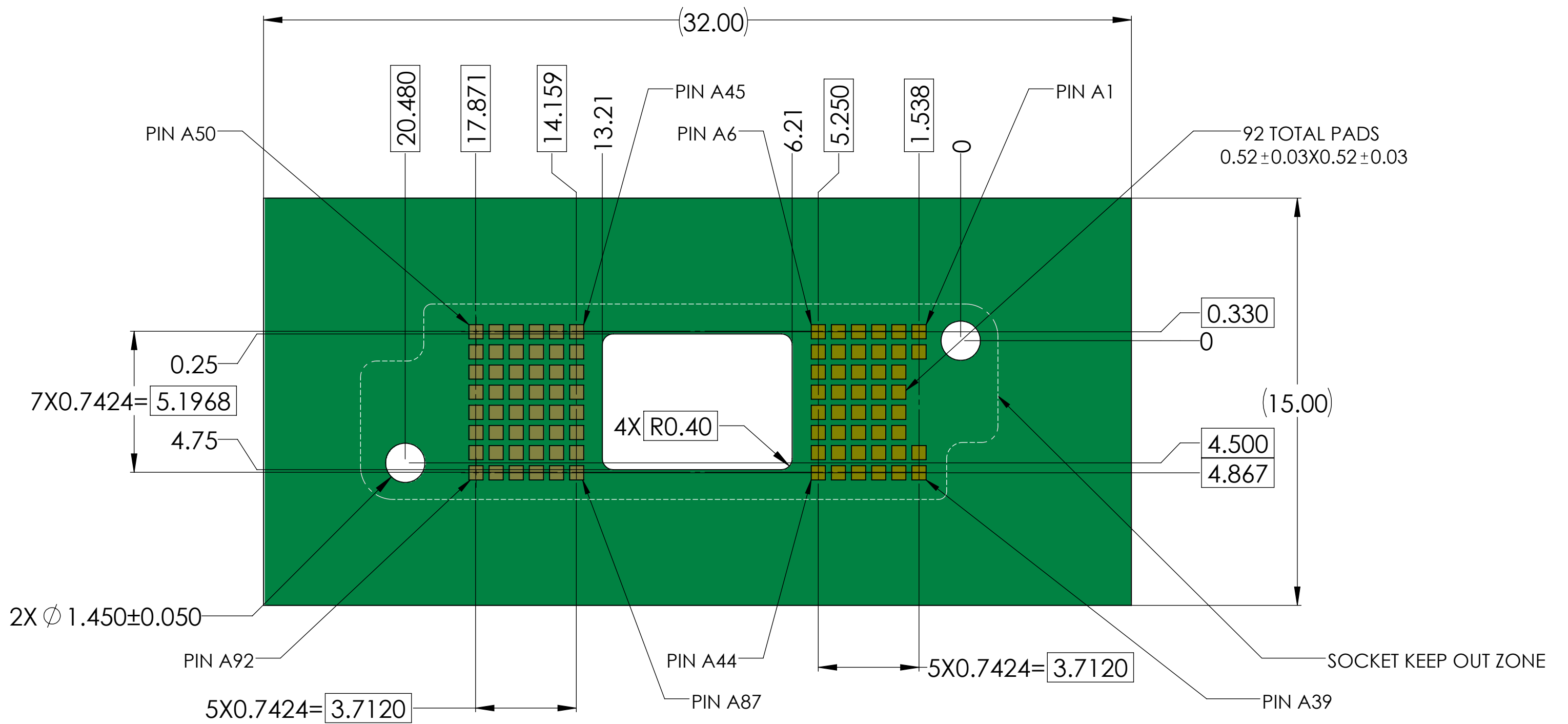
Revisions			
REV	ECN #	Description	Date
B	R20180001	Update the package SPEC.	2018/03/07
C	R20210007	Update the flange to single tip	2021/10/06
D	R20220001	Modify Flange height spec	2022/02/22



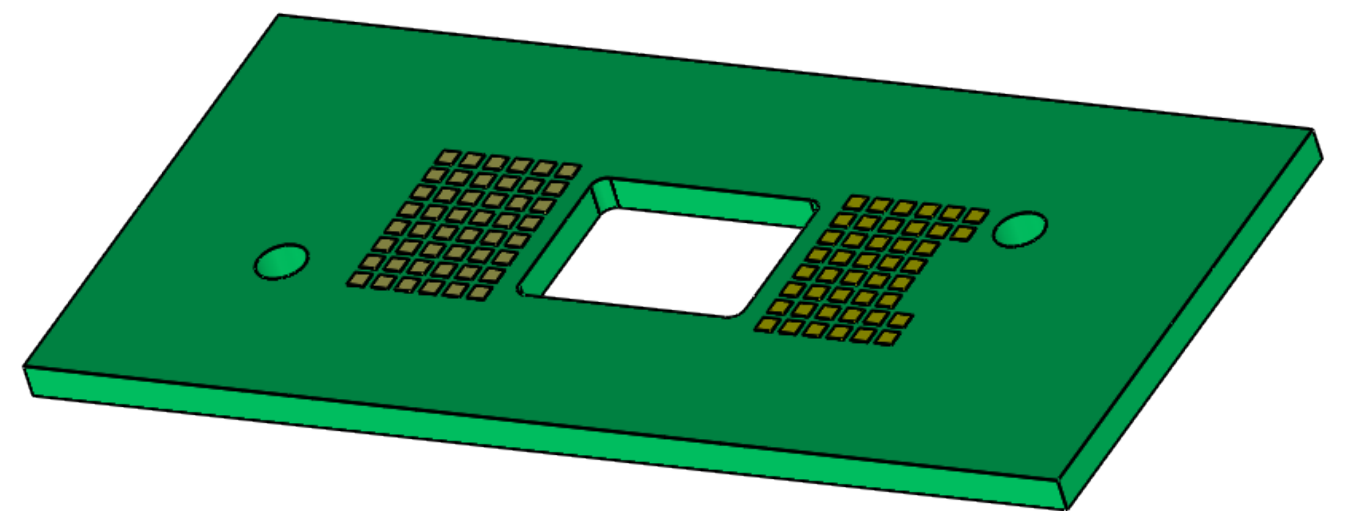
NOTES:(UNLESS OTHERWISE SPECIFIED)

1. INTERPRET DRAWING PER ASME Y14.5-94.
2. COMPLIANT WITH RoHS DIRECTIVE 2011/65/EU
3. CENTER MARKS OF CONTACT POSITIONS ARE FOR COMPRESSED

	DIMENSIONS ARE IN MM [INCH] .X ± 0.13 [.005] .XX ± 0.08 [.003] .XXX ± 0.04 [.001] ANGLE: NO DEC ± 1° .X ± 0.5° .XX ± 0.25°		MATERIAL: FINISH: -- DRAWN BY: Jianyu 2022/02/22 CHECKED BY: Jason Wu 2022/02/22 ENGR APPR: Gary Hsieh 2022/02/22 MFG APPR: QA APPR:		TITLE: 92POS PCB Beam Interposer LGA-LGA,0.7424 Pitch DWG. NO.: BBX0092CMMHFAU00 SCALE: 5:1	
	THIRD ANGLE		SIZE: B+		SHEET 1 OF 3	
					REV D	



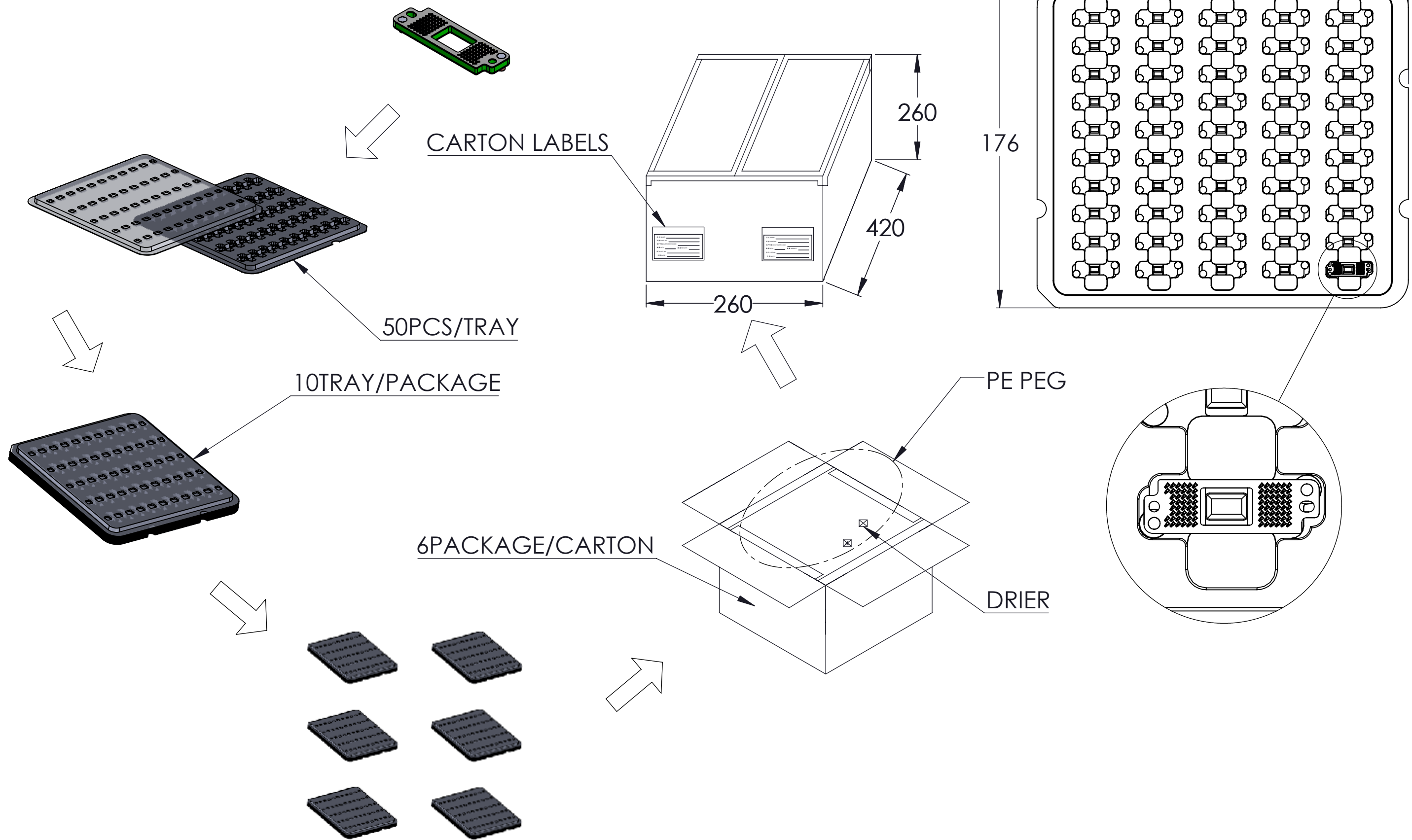
Recommend PCB Footprint



- NOTE(UNLESS OTHERWISH SPECIFIED):
- 1.PADS TO BE ELECTROLESS NICKEL/IMMERSION GOLD (ENIG) PLATED
 - 2.VIAS IN PAD AREAS MUST BE FILLED
 - 3.INTERPOSER OUTLINE;NO COMPONENTS ALLOWED WITHIN THIS AREA
 - 4.ALLOWED COMPONENT AREA; MAXIMUM COMPONENT HEIGHT 1.3 mm
 - 5.IF SOLDERMASK IS APPLIED IN THE ARRAY AREA.IT SHALL NOT PROTRUDE ABOVE THE PLANE OF THE CONTACT PAD SURFACE

	DIMENSIONS ARE IN MM [INCH]		MATERIAL:		TITLE:	
	.X ± 0.13 [.005]	✓	FINISH: --	92POS PCBeam Interposer LGA-LGA,0.7424 Pitch		
	.XX ± 0.08 [.003]		DRAWN BY: Jianyu 2022/02/22	SIZE	DWG. NO.:	
	.XXX ± 0.04 [.001]		CHECKED BY: Jason Wu 2022/02/22	B+	BBX0092CMMHFAU00	
ANGLE: NO DEC ± 1°		ENGR APPR: Gary Hsieh 2022/02/22	MFG APPR:	SCALE: 2.5:1	SHEET 2 OF 3	
.X ± 0.5*		QA APPR:				
.XX ± 0.25*						

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NOTE(UNLESS OTHERWISH SPECIFIED):
1.COMPONENT LOAD PER TRAY : 50PCS
10 TRAY/PACKAGE:500 PCS
6 PACKAGE/CARTON: 420mm X 260mm X 260mm.
TOTAL: 3000PCS/CARTON
2.MATERIAL:TRANSPARENT POLYSTYRENE(PS).

	DIMENSIONS ARE IN MM [INCH] .X ± 0.13 [.005] .XX ± 0.08 [.003] .XXX ± 0.04 [.001] ANGLE: NO DEC ± 1° .X ± 0.5° .XX ± 0.25°		MATERIAL: FINISH: -- DRAWN BY: Jianyu 2022/02/22 CHECKED BY: Jason Wu 2022/02/22 ENGR APPR: Gary Hsieh 2022/02/22 MFG APPR: QA APPR:		TITLE: 92POS PCBeam Interposer LGA-LGA,0.7424 Pitch DWG. NO.: B+ BBX0092CMMHFAU00 SCALE: 2.5:1 SHEET 3 OF 3	
	THIRD ANGLE		SIZE: B+		REV: D	